

JAN 30 2006

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application Serial No. .... 10/734,995  
Filing Date ..... December 12, 2003  
Inventor ..... Nishant Sinha  
Assignee ..... Micron Technology, Inc.  
Group Art Unit ..... 2812  
Examiner ..... Scott Geyer  
Attorney Docket No. .... MI22-2464  
Title: ..... Methods for Removal of Organic Materials

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**CERTIFICATE OF FACSIMILE TRANSMISSION UNDER 37 CFR § 1.8**

I hereby certify that the following papers are being facsimile transmitted to the Patent and Trademark Office at (571) 273-8300 on the date shown below:

1. Certificate of Facsimile Transmission
2. Response to December 30, 2005 Notice of Non-Compliant Response

Dated: 1/30/2006By: 

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**FEE DEFICIENCY**

Although it is believed that no fees are due, the Commissioner is hereby authorized to charge any fees under 37 C.F.R. 1.16 and 1.17 which may be required by this paper to Deposit Account No. 23-0925.

Dated: 1/30/06By: 

Robert C. Hyta

Reg. No. 46,791

**NUMBER OF PAGES IN FACSIMILE: 11**

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Application Serial No. .... 10/734,995  
Confirmation No. .... 2050  
Filing Date ..... December 12, 2003  
Inventor ..... Nishant Sinha  
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Examiner ..... Scott Geyer  
Attorney's Docket No. .... MI22-2464  
Customer No. .... 021567  
Title ..... Methods for Removal of Organic Materials (As Amended)

**RESPONSE TO DECEMBER 30<sup>th</sup>, 2005 NOTICE OF NON-COMPLIANT RESPONSE**

To: Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
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**AMENDMENTS**

**Amendment to the Title**

Please amend the title as follows:

~~Methods for Forming Capacitor Structures;~~ and Methods for Removal of Organic  
Materials